Anodic Dissolution Model Parameterization for Pulsed Electrochemical Machining Coupled with a Magnetic Field C. Bradley U.S. Army RDECOM-ARDEC, Benét Laboratories, Watervliet, NY 12189, USA

**INTRODUCTION**: Magnetically assisted pulsed electrochemical machining (PECM) extends the capabilities of traditional ECM for tungsten carbide and super alloys. Magnetic fields can increase the material removal rate (MRR), but also complicates material removal prediction [1].



**RESULTS**: The machined hole was captured using a structured light surface scanner. The total volume error for the two experiments had a mean of 4% regardless of current limit. This indicates the volume and MRR are well parameterized by the  $Y_{ave}$  and  $\theta$ . Separately, the alpha shape combines the simulated hole from Fig. 3 and experimental hole scan in Fig. 4. The alpha shape represents the XOR of the holes, the volume of this alpha shape is shown in Fig. 5. When the XOR volume is

 Table 1. PECM Conditions

Figure 1. PECM Flow Cell w/ Magnets

Bipolar current pulses occurring on a small time scale determine the anodic dissolution (AD) rate that defines the geometry on a much larger total machining time scale. Parameters that capture machining performance are necessary to bridge these time scales to allow prediction.

**COMPUTATIONAL METHODS**: The concentration-dependent current distribution has upper and lower current limits and is solved simultaneously with mesh deformation which simulates AD using the arbitrary Lagrangian-Eulerian (ALE) divided by the total scanned hole volume it is a robust measure that quantifies morphological simulation error, shown in Fig. 6 [2]. The best  $1\sigma$  error in Fig. 6 is at a surface current limit of 0.08 A/mm<sup>2</sup>.



Figure 3. Displacement surface of simulation Figure 4. Surface scan from experiment



method. Additionally, the convection-diffusion equation is solved for the transport of dissolved metal ions which limits the current distribution. A sweep of surface current limits was simulated to asses parameterization. Average pulse conductivity ( $Y_{ave}$ ) and Faraday efficiency ( $\theta$ ) were chosen to parameterize magnetically assisted PECM machining as ECM in the simulation.

$$\frac{\partial \boldsymbol{c}}{\partial t} = \nabla \cdot (D\nabla c) - \mathbf{u} \cdot \nabla c + \frac{\theta m}{M_{\text{eqv}}} \,\mathrm{d}t$$

The deformed mesh from the COMSOL 5.2<sup>™</sup> simulation is shown in Fig. 2.



**Figure 5**. XOR of simulation and experimental **Figure 6**. XOR volume error versus holes at *i* limit 0.08 A/mm<sup>2</sup> current limit, 1σ bars

The total volume was near constant, independent of the current limit, whereas the morphology is highly affected by the current limit, seen in Fig. 6.

**CONCLUSIONS:** parameterizing machining By performance the total volume and MRR could be accurately simulated from a measured  $Y_{ave}$  and  $\theta$ . However, the morphology requires additional measures to parameterize the machining conditions including the current limit and possibly other parameters. The machining environment parameters of magnetic field flux density and PECM current frequency interact in a complex manner that is difficult to predict, but MRR is characterized using  $Y_{ave}$  and  $\theta$ . This parameterization has the potential to simplify navigating and optimizing within the complex parameter space of magnetically assisted PECM.

$$\boldsymbol{m} = \boldsymbol{\theta} \left( \frac{\boldsymbol{Q}}{F} \right) \left( \frac{M_{\text{eqv}}}{z_{\text{eqv}}} \right) \,, \,\,\, \boldsymbol{Q} = \int_0^{t_{\text{final}}} \boldsymbol{Y}_{\text{ave}} \cdot V \,\mathrm{d}t$$

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